

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5311504

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST
CONVEYING PARTY DATA	
Name	Execution Date
NFS LEASING, INC.	01/07/2019
RECEIVING PARTY DATA	
Name:	D & D MANUFACTURING, LLC
Street Address:	135 GUS HIPPI BLVD.
City:	ROCKLEDGE
State/Country:	FLORIDA
Postal Code:	32955
PROPERTY NUMBERS Total: 36	
Property Type	Number
Patent Number:	9188364
Patent Number:	9168690
Patent Number:	8813741
Patent Number:	8691038
Patent Number:	8535582
Patent Number:	8518202
Patent Number:	8371839
Patent Number:	8371837
Patent Number:	8192664
Patent Number:	8091314
Patent Number:	8070471
Patent Number:	7980042
Patent Number:	7955550
Patent Number:	7931845
Patent Number:	7923095
Patent Number:	7874125
Patent Number:	7842226
Patent Number:	7842225
Patent Number:	7837917
Patent Number:	7779595

Property Type	Number
Patent Number:	7726912
Patent Number:	7517174
Patent Number:	7208219
Patent Number:	6900547
Patent Number:	6869558
Patent Number:	6719551
Patent Number:	8156690
Application Number:	13144254
Application Number:	13877042
Application Number:	14114865
Application Number:	14349164
Application Number:	14405070
Application Number:	14519652
Application Number:	14519689
Application Number:	14672753
Application Number:	14714709

CORRESPONDENCE DATA

Fax Number: (617)275-4006

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 617.391.2168

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Address Line 2: MIRICK O'CONNELL

Address Line 4: BOSTON, MASSACHUSETTS 02110

ATTORNEY DOCKET NUMBER:	28267-00001
NAME OF SUBMITTER:	PING HU, ESQ.
SIGNATURE:	/Ping Hu, Esq./
DATE SIGNED:	01/07/2019

Total Attachments: 5

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RELEASE OF INTELLECTUAL PROPERTY SECURITY INTEREST

This RELEASE OF INTELLECTUAL PROPERTY SECURITY INTEREST (“**Release**”) is made and effective as of January 7, 2019 and granted by NFS Leasing, Inc., a Massachusetts Corporation (“**Secured Party**”) in favor of D & D Manufacturing, LLC, a Florida limited liability company (“**Grantor**”) and its successors, assigns, and legal representatives.

WHEREAS, the Secured Party and the Grantor executed certain INTELLECTUAL PROPERTY SECURITY AGREEMENT dated as of October 24, 2017 (the “**IP Security Agreement**”), recorded with the United States Patent and Trademark Office (USPTO) at Reel 044115, Frame 0883 on November 14, 2017;

WHEREAS, pursuant to the IP Security Agreement, the Grantor pledged and granted to the Secured Party for the benefit of the Secured Party a security interest in and to all of the right, title and interest of such Grantor in, to and under the Collateral (as defined in the IP Security Agreement);

WHEREAS, the Grantor has requested that the Secured Party enter into this Release in order to effectuate, evidence and record the release and reassignment to the Grantor of any and all right, title and interest the Secured Party may have in the IP Collateral (as defined below) pursuant to the IP Security Agreement.

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the Secured Party hereby states as follows:

1. Release of Security Interest. The Secured Party, its successors, legal representatives and assigns, hereby terminates the IP Security Agreement and terminates, releases and discharges any and all security interests that it has pursuant to the IP Security Agreement in any and all right, title and interest of the Grantor, and reassigns to the Grantor any and all right, title and interest that it may have, in, to and under the following (collectively, the “**IP Collateral**”):

(a) any and all patents, patent applications and other patent rights and any other governmental authority-issued indicia of invention ownership, including the patents and patent applications listed in Schedule 1 hereto, and all reissues, divisions, continuations, continuations-in-part, renewals, extensions and reexaminations thereof and amendments thereto, in the U.S. and worldwide (the “**Patents**”);

(b) any and all trademarks, service marks, trade names, brand names, logos, trade dress, design rights and other similar designations of source, whether registered or unregistered, together with the goodwill connected with the use thereof and symbolized thereby and all extensions and renewals thereof (“**Trademarks**”);

(c) any and all copyrights, copyright applications and registrations, and like protections in each work of authorship, whether registered or unregistered and whether published or unpublished, and all extensions and renewals thereof (“**Copyrights**”);

(d) all rights of any kind whatsoever of such Grantor accruing under any of the foregoing provided by applicable law of any jurisdiction, by international treaties and conventions and otherwise throughout the world;

(e) any and all license and other agreements in which such Grantor has granted or is granted a license or other right under any Patent, Trademark, or Copyright;

(f) any and all royalties, fees, income, payments and other proceeds now or hereafter due or payable with respect to any and all of the foregoing; and

(g) any and all claims and causes of action, with respect to any of the foregoing, whether occurring before, on or after the date hereof, including all rights to and claims for damages, restitution and injunctive and other legal and equitable relief for past, present and future infringement, misappropriation, violation, misuse, breach or default, with the right but no obligation to sue for such legal and equitable relief and to collect, or otherwise recover, any such damages.

2. Further Assurances. The Secured Party agrees, at the expense of the Grantor, its successors, assigns, or legal representatives, to take all further actions, and provide to the Grantor, its successors, assigns, and legal representatives all such cooperation and assistance, including, without limitation, the execution and delivery of any and all further documents or other instruments, as the Grantor, its successors, assigns, and legal representatives may reasonably request in order to confirm, effectuate or record this Release.

3. Governing Law. This Release and any claim, controversy, dispute or cause of action (whether in contract or tort or otherwise) based upon, arising out of or relating to this Release and the transactions contemplated hereby shall be governed by, and construed in accordance with, the laws of the United States and the Commonwealth of Massachusetts, without giving effect to any choice or conflict of law provision or rule (whether of the Commonwealth of Massachusetts or any other jurisdiction).

IN WITNESS WHEREOF, the Secured Party has caused this Release to be duly executed and delivered by its officer thereunto duly authorized as of the date first above written.

NFS Leasing, Inc.

Secured Party

By: 

Name: Mark Blaisdell

Title: CFO

Schedule I

Patents

U.S. Patents and Patent Applications

Patent/Application No.	Title
9,188,364	Parabolic solar energy collector apparatus
9,168,690	Expanded compression of composite plastics
8,813,741	Stationary parabolic solar power system and related methods for collecting solar energy
8,691,038	Method of forming a molded article from thermoformable thermoplastic sheets
8,535,582	Method of forming a molded article by wireless control
8,518,202	Method and apparatus for forming a shaped multilayered molded article
8,371,839	Apparatus of preparing a molded article
8,371,837	Apparatus of preparing a molded article
8,192,664	Thermoplastic molding process and apparatus
8,091,314	load Bearing assembly
8,070,471	Gravity Injection of molding material for compression molding and related met.
7,980,042	Molded panel, molded panel system and connection system
7,955,550	Method of preparing a molded article
7,931,845	Gravity Injection of molding material for compression molding and related met.
7,923,095	Method of forming a molded plastic article having molded extensions
7,874,125	Molded support beam
7,842,226	Method of preparing a molded article
7,842,225	Method of preparing a molded article
7,837,917	Method of forming a molded plastic article having molded extensions
7,779,595	Molded panel and panel assembly
7,726,912	Support structure
7,517,174	Molded pile
7,208,219	Thermoplastic molding process and apparatus
6,900,547	Thermoplastic molding process and apparatus
6,869,558	Thermoplastic molding process and apparatus
6,719,551	Thermoplastic molding process and apparatus
8,156,690	Enclosed structure
20150276095	Multi-section length of pipe and associated methods for making same
20150145181	Method and Apparatus for Preparing a Molded article
20150108690	Sheet Die Apparatus with Direct Extruder Interface and associated methods
20150108689	Plastic Molding Apparatus with and adjustable barrel and associated methods
20140059974	Polymer Composite Beam with In-Molded Flange Inserts
20150329378	Multi-Effect Solar Distillation System and Associated Methods
20140246011	Solar Heat Exchange Panel

20130193611 Composite Polymeric Flowforming with and X-V Mold Base
 20120018134 Heat Exchange Panel

Foreign Patents and Patent Applications

Country/ Region	Application No.	Patent No.	Issue Data	Filing Date
CA	2003002507040	2,507,040	07/10/2012	11/12/2003
CN	200380108751	ZL200380108751.5	03/12/2008	11/12/2003
HK	6110850.2	HK1090329	06/20/2008	11/12/2003
MX	MX2005PA0005204			05/13/2005
CA	2,562,110	2,562,110	03/08/2005	03/08/2005
CN	CN2005080010301.1	CN200580010301.1	11/24/2010	03/08/2005
IN	3561/CHENP/2006	240820	06/02/2010	03/08/2005
MX	MX2006PA0010721	253732	01/23/2008	09/19/2006
SG	200606489.3	125703	10/31/2007	03/08/2005
CA	CA2007002666445	2,666,445	01/7/2014	10/11/2007
MX	MX/a/2008/00889	312423	08/16/2013	07/09/2008
CA	2,684,607	2,684,607	05/26/2015	10/19/2009
CN	CN200880012822.4	ZL20080012822.4	01/16/2013	10/20/2009
JP	2010-504143	5342546	11/13/2013	10/15/2009
KR	10-2009-7024135	10-1449080	10/01/2014	11/19/2009
CA	2,698,698	2,698,698	10/28/2014	03/05/2010
CN	CB200880114918.1	ZL200880114918.1	07/31/2013	02/05/2010
KR	10-2010-7007391	10-1492298	02/04/2015	04/05/2010
MX	MXa/2010/002237			02/25/2010
CN	CN200980151959.2	ZL200980151959.2	04/09/2014	04/14/2011
JP	2011-533179	5500604	03/20/2014	10/22/2009
CN	CN201080010514.5	ZL201080010514.5	02/27/2013	09/05/2011
CN	CN10736146.1	ZL201080012554.3	02/19/2014	09/19/2011
CN	CN200380108751			11/12/2003
EP	EP2003000781880			11/12/2003
CA	2,740,611			10/22/2009
CA	2,748,279			01/13/2010
IN	5921/DELNP/2011			01/13/2010
MX	MX/a/2011/007457			01/13/2010
CA	2,750,802			01/29/2010
CA	2,839,791			04/27/2012
MX	MX/a/2013/012835			04/27/2012
CA	2,850,759			10/02/2012
CN	CN2012800481015			10/02/2012
EP	12837835.3			10/02/2012

MX	MA/a/2014/003965	10/02/2012
CA	2,874,457	06/08/2013
CN	CN2013800294314	06/08/2013
EP	13800537.6	06/08/2013
MX	MX/a/2014/014469	06/08/2013
BR	BR2003000016221	11/12/2003
BR	BR18110026001	07/08/2011